

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











RF POWER MOSFETs

N-CHANNEL ENHANCEMENT MODE

125V 100W 100MHz

The ARF463A and ARF463B comprise a symmetric pair of common source RF power transistors designed for pushpull scientific, commercial, medical and industrial RF power amplifier applications up to 100 MHz. They have been optimized for both linear and high efficiency classes of operation.

- Specified 125 Volt, 81.36 MHz Characteristics:
- Low Cost Common Source RF Package.
- **Output Power = 100 Watts.**
- Low Vth thermal coefficient.

Gain = 15dB (Class AB)

• Low Thermal Resistance.

Efficiency = 75% (Class C)

Optimized SOA for Superior Ruggedness.

MAXIMUM RATINGS

All Ratings: $T_C = 25^{\circ}$ C unless otherwise specified.

Symbol	Parameter	ARF463A/B(G)	UNIT	
V _{DSS}	Drain-Source Voltage	500	Volts	
I _D	Continuous Drain Current @ T _C = 25°C	9	Amps	
V _{GS}	Gate-Source Voltage	±30	Volts	
P _D	Total Power Dissipation @ T _C = 25°C	180	Watts	
$R_{\theta JC}$	Junction to Case	0.70	°C/W	
T _J ,T _{STG}	Operating and Storage Junction Temperature Range	-55 to 150	- °C	
T _L	Lead Temperature: 0.063" from Case for 10 Sec.	300		

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV _{DSS}	Drain-Source Breakdown Voltage $(V_{GS} = 0V, I_D = 250 \mu A)$	500			Volto
V _{DS} (ON)	On State Drain Voltage $^{\textcircled{1}}$ (I _D (ON) = 4.5A, V _{GS} = 10V)			5.0 Volts	
ı	Zero Gate Voltage Drain Current (V _{DS} = V _{DSS} , V _{GS} = 0V)			25	
Zero Gate Voltage Drain Current (V _{DS} = 0.8 V _{DSS} , V _{GS} = 0V, T _C = 125°C)				250	μΑ
I _{GSS}	Gate-Source Leakage Current $(V_{GS} = \pm 30V, V_{DS} = 0V)$			±100	nA
g _{fs}	Forward Transconductance $(V_{DS} = 25V, I_{D} = 4.5A)$	4	6		mhos
V _{GS} (TH)	Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 50 \text{mA})$	3		5	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

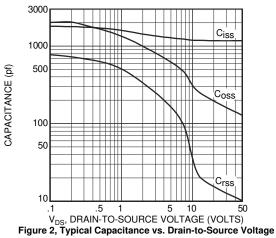
Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C _{iss}	Input Capacitance	V _{GS} = 0V		1200	1600	
C _{oss}	Output Capacitance	$V_{DS} = 50V$		140	200	рF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		9	12	
t _{d(on)}	Turn-on Delay Time	V _{GS} = 15V		5.1	10	
t _r	Rise Time	$V_{DD} = 0.5 V_{DSS}$		4.1	8	ns
t _{d(off)}	Turn-off Delay Time	I _D = I _{D[Cont.]} @ 25°C		12.8	20	113
t _f	Fall Time	$R_{G} = 1.6\Omega$		4	8	

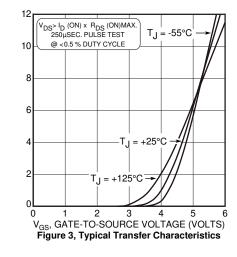
FUNCTIONAL CHARACTERISTICS

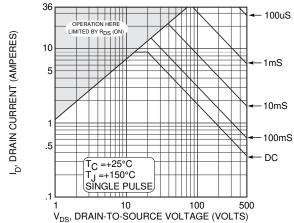
Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT	
G _{PS}	Common Source Amplifier Power Gain	f = 81.36 MHz	13	15		dB	
η	Drain Efficiency	$I_{dq} = 50 \text{mA}$ $V_{DD} = 125 \text{V}$	60	65		%	
Ψ	Electrical Ruggedness VSWR 10:1	P _{out} = 100W	No Deg	lo Degradation in Output Power			

①Pulse Test: Pulse width < 380 μS, Duty Cycle < 2%

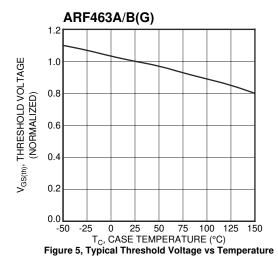
APT Reserves the right to change, without notice, the specifications and information contained herein.

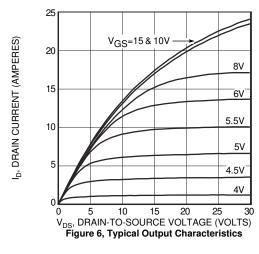


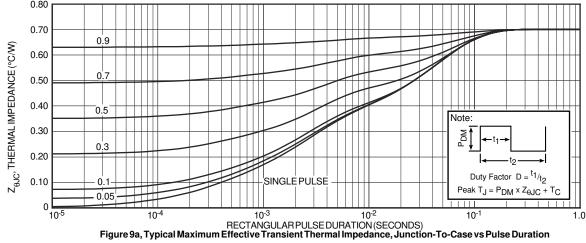




ID, DRAIN CURRENT (AMPERES)







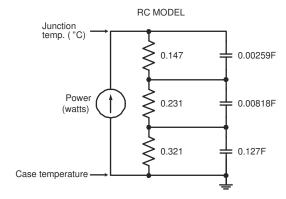


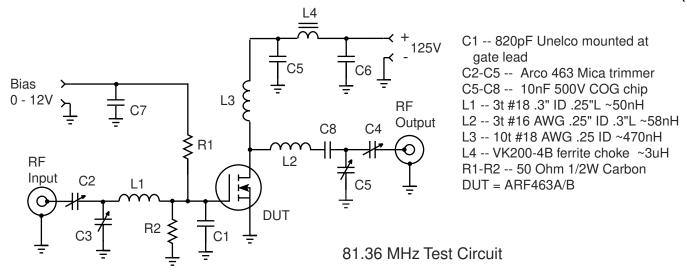
Figure 9b, TRANSIENT THERMAL IMPEDANCE MODEL

Table 1 - Typical Class AB Large Signal Input - Output Impedance

Freq. (MHz)	Z _{in} (Ω)	Z _{OL} (Ω)
2.0	24 - j 5.0	55 - j 4.8
13.5	7.8 - j 11	41 - j 24
27	2.1 - j 6.4	23 - j 26.2
40	.74 - j 3.3	13.6 - j 22
65	.30 + j .42	6.1 - j 14.2
80	.46 + j 2.0	4.2 - j 10.7
100	.87 + j 3.7	2.7 - j 7.1

HAZARDOUS MATERIAL WARNING The ceramic portion of the device between leads and mounting surface is beryllium oxide,

BeO. Beryllium oxide dust is toxic when in-



TO-247 Package Outline

e3 100% Sn Plated

